

## General Description

The AOZ8906CI is a transient voltage suppressor array designed to protect high speed data lines such as HDMI, USB 2.0, MDDI, SATA, and Gigabit Ethernet from damaging ESD events.

This device incorporates eight surge rated, low capacitance steering diodes and a TVS in a single package. During transient conditions, the steering diodes direct the transient to either the positive side of the power supply line or to ground.

The AOZ8906CI provides a typical line to line capacitance of 1pF making it ideally suited for HDMI 1.3 or USB 2.0 applications, such as Digital TVs, DVD players, Computing, set-top boxes and MDDI applications in mobile computing devices.

The AOZ8906CI comes in RoHS compliant and halogen free SOT23-6L package and is rated -40°C to +85°C junction temperature range.

## Features

- ESD protection for high-speed data lines:
  - IEC 61000-4-2, level 4 (ESD) immunity test
  - ±30kV (air discharge) and ±30kV (contact discharge)
  - IEC61000-4-4 (EFT) 40A (5/50nS)
  - IEC61000-4-5 (Lightning) 7A (8/20µS)
  - Human Body Model (HBM) ±30kV
- Array of surge rated diodes with internal TVS diode
- Protects four I/O lines
- Low capacitance between I/O lines: 1pF
- Low clamping voltage
- Low operating voltage: 5.0V

## Applications

- HDMI, USB 2.0, MDDI, SATA ports
- Monitors and flat panel displays
- Set-top box
- Video graphics cards
- Notebook computers



## Typical Application

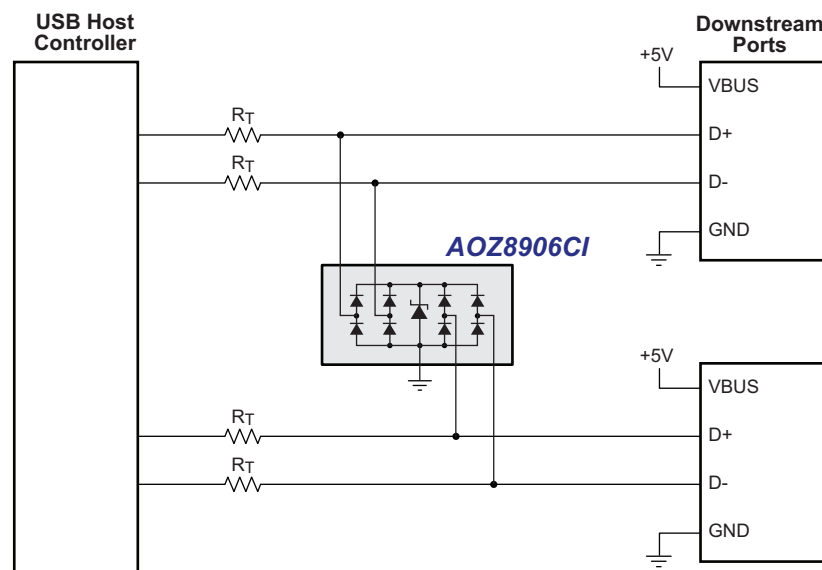


Figure 1. USB High Speed Ports

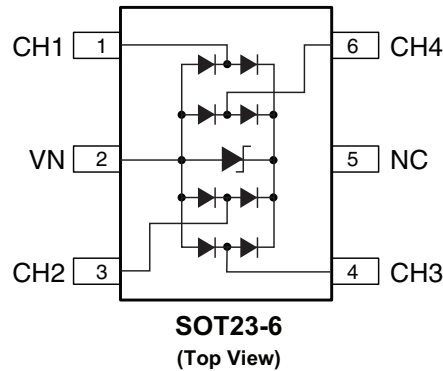
## Ordering Information

Part Number	Ambient Temperature Range	Package	Environmental
AOZ8906CI	-40°C to +85°C	SOT23-6L	RoHS Compliant Green Product



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant. Please visit [www.aosmd.com/media/AOSGreenPolicy.pdf](http://www.aosmd.com/media/AOSGreenPolicy.pdf) for additional information.

## Pin Configuration



## Absolute Maximum Ratings

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
Storage Temperature ( $T_S$ )	-65°C to +150°C
ESD Rating per IEC61000-4-2, contact <sup>(1)</sup>	±30kV
ESD Rating per IEC61000-4-2, air <sup>(1)</sup>	±30kV
ESD Rating per Human Body Model <sup>(2)</sup>	±30kV

### Notes:

- IEC 61000-4-2 discharge with  $C_{Discharge} = 150\text{pF}$ ,  $R_{Discharge} = 330\Omega$ .
- Human Body Discharge per MIL-STD-883, Method 3015  $C_{Discharge} = 100\text{pF}$ ,  $R_{Discharge} = 1.5\text{k}\Omega$ .

## Maximum Operating Ratings

Parameter	Rating
Junction Temperature ( $T_J$ )	-40°C to +125°C

## Electrical Characteristics

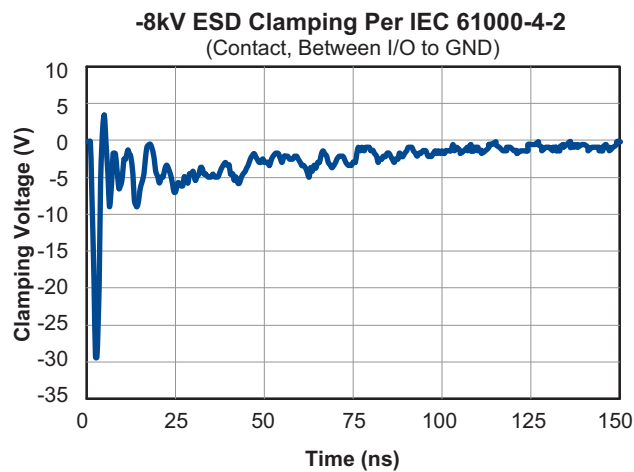
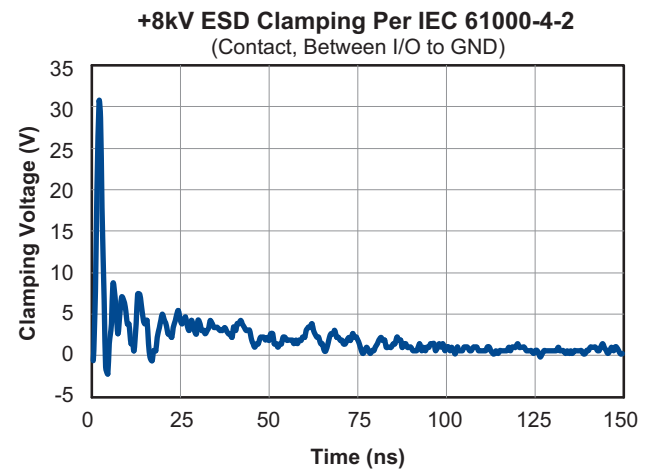
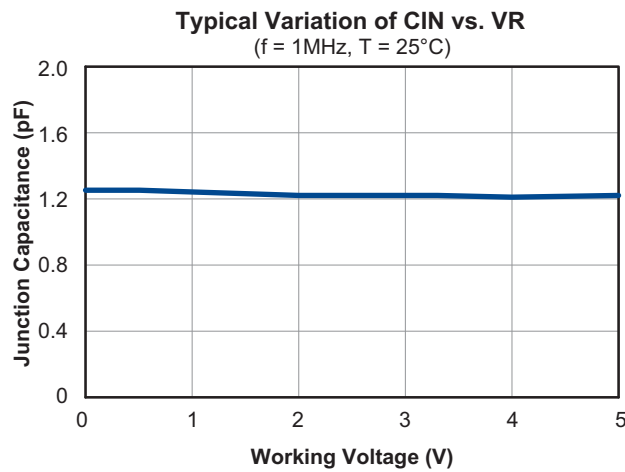
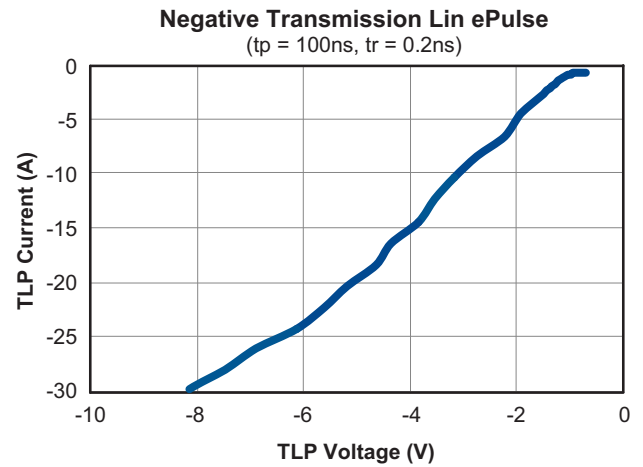
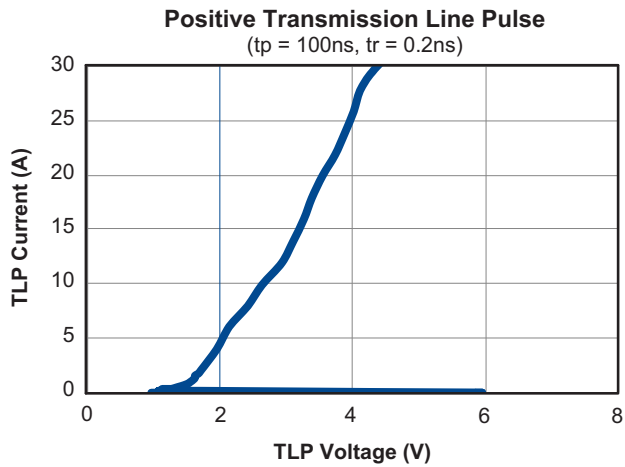
$T_A = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
$V_{RWM}$	Reverse Working Voltage	Between I/O and VN <sup>(3)</sup>			5.5	V
$V_{BR}$	Reverse Breakdown Voltage	$I_T = 100\mu\text{A}$ , between I/O and VN <sup>(4)</sup>	6.6			V
$I_R$	Reverse Leakage Current	$V_{RWM} = 5\text{V}$ , between I/O and VN			1	$\mu\text{A}$
$V_F$	Diode Forward Voltage	$I_F = 15\text{mA}$	0.70	0.85	1	V
$V_{CL}$	Channel Clamp Voltage Positive Transients Negative Transients	$I_{PP} = 16\text{A}$ , $t_p = 100\text{ns}$ , any I/O pin to Ground <sup>(5)</sup>			4.1 -5.3	V
	Channel Clamp Voltage Positive Transients Negative Transients	$I_{PP} = 30\text{A}$ , $t_p = 100\text{ns}$ , any I/O pin to Ground <sup>(5)</sup>			5.2 -9.9	V
	Channel Clamp Voltage Any I/O Pin to Ground	$I_{PP} = 7\text{A}$ , $t_p = 8/20\mu\text{s}$			8	V
$C_j$	Channel Input Capacitance	$V_R = 0\text{V}$ , $f = 1\text{MHz}$ , between I/O pins		1	1.5	pF
		$V_R = 0\text{V}$ , $f = 1\text{MHz}$ , any I/O pin to Ground		0.5	0.8	pF
$R_{DYN}$	Dynamic Resistance	$I_{TLP} = 16\text{A to }30\text{A}$		0.15		$\Omega$
		$I_{TLP} = -16\text{A to }-30\text{A}$		0.3		$\Omega$

### Notes:

- The working peak reverse voltage,  $V_{RWM}$ , should be equal to or greater than the DC or continuous peak operating voltage level.
- $V_{BR}$  is measured at the pulse test current  $I_T$ .
- Measurements performed using a 100ns Transmission Line Pulse (TLP) system.

## Typical Performance Characteristics



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2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.